

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

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|--------------------------------|---|---------------------|
| In the Application of: |) | |
| JAKOB et al. |) | |
| |) | |
| Filing Date: November 18, 2005 |) | Art Unit: 2813 |
| |) | |
| Serial No. 10/536,725 |) | Examiner: L.M. Menz |

For: **METHOD AND DEVICE FOR MACHINING A WAFER,
IN ADDITION TO A WAFER COMPRISING A
SEPARATION LAYER AND A SUPPORT LAYER**

Response

Commissioner for Patents
PO Box 1450
Alexandria, VA 22313-1450

June 30, 2008

Dear Sir:

In response to the June 2, 2008 Office Action, Applicants respond as follows.